

Applications

- Repeaters
- Mobile Infrastructure
- Defense/Aerospace
- LTE / WCDMA / EDGE / CDMA
- General Purpose Wireless
- IF amplifier, RF driver amplifier

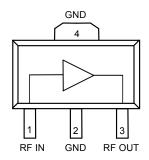
TrQuint TOP 3M 9028

SOT-89 Package

Product Features

- 50-4000 MHz
- Flat gain $(14.7 \pm 0.3 \text{ dB})$ from 0.5 3.5 GHz
- +40 dBm Output IP3
- 2 dB Noise Figure @ 1.9 GHz
- No RF component needed; 50 Ω gain block
- Unconditionally stable
- +5V Single Supply, 85 mA Current
- SOT-89 Package

Functional Block Diagram



General Description

The TQP3M9028 is a cascadable, high linearity gain block amplifier in a low-cost surface-mount package. At 1.9 GHz, the amplifier typically provides 14.7 dB gain, +40 dBm OIP3, and 2 dB Noise Figure while only drawing 85 mA current. The device is housed in a leadfree/green/RoHS-compliant industry-standard SOT-89 package.

The TQP3M9028 has the benefit of having excellent gain flatness across a broad range of frequencies. The low noise figure and high linearity performance allows the device to be used in both receiver and transmitter chains for high performance systems. The amplifier is internally matched using a high performance E-pHEMT process and only requires an external RF choke and blocking/bypass capacitors for operation from a single +5V supply. The internal active bias circuit also enables stable operation over bias and temperature variations.

The TQP3M9028 covers the 0.05-4 GHz frequency band and is targeted for wireless infrastructure or other applications requiring high linearity and/or low noise figure.

Pin Configuration

| Pin # | Symbol | | |
|-------|-----------------------------|--|--|
| 1 | RF Input | | |
| 3 | RF Output / V _{dd} | | |
| 2, 4 | Ground | | |

Ordering Information

| Part No. | Description |
|------------------|-------------------------------|
| TQP3M9028 | High Linearity LNA Gain Block |
| TQP3M9028-PCB_IF | TQP3M9028 EVB 0.05-0.5 GHz |
| TQP3M9028-PCB_RF | TQP3M9028 EVB 0.5-4 GHz |

Standard T/R size = 1000 pieces on a 7" reel.



Specifications

Absolute Maximum Ratings

| Parameter | Rating |
|--|----------------|
| Storage Temperature | -65 to +150 °C |
| RF Input Power, CW,50 Ω ,T = 25°C | +23 dBm |
| Device Voltage, V _{dd} | +7 V |
| Reverse Device Voltage | -0.3V |

Operation of this device outside the parameter ranges given above may cause permanent damage.

Recommended Operating Conditions

| Parameter | Min | Тур | Max | Units |
|-------------------------------------|-------|-----|-------|-------|
| V_{dd} | +4.75 | +5 | +5.25 | V |
| T _{case} | -40 | | 85 | °C |
| Tj (for>10 ⁶ hours MTTF) | | | 190 | °C |

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

Electrical Specifications

Test conditions unless otherwise noted: $+25^{\circ}\text{C}$, +5V Vsupply, $50\ \Omega$ system.

| Parameter | Conditions | Min | Typical | Max | Units |
|--|-------------|---------------------|---------|------|-------|
| Operational Frequency Range | | 50 | | 4000 | MHz |
| Test Frequency | | | 1900 | | MHz |
| Gain | | 13 | 14.5 | 16 | dB |
| Input Return Loss | | was traditional set | 18 | | dB |
| Output Return Loss | | | 19 | | dB |
| Output P1dB | | | +20.7 | | dBm |
| Output IP3 | See Note 1. | +36 | +40 | | dBm |
| Noise Figure | | | 2 | | dB |
| V_{dd} | | | +5 | | V |
| Current, I _{dd} | | | 85 | 100 | mA |
| Thermal Resistance (jnc to case) θ_{jc} | | | 36.6 | | °C/W |

Notes

1. OIP3 measured with two tones at an output power of +4 dBm / tone separated by 1 MHz. The suppression on the largest IM3 product is used to calculate the OIP3 using 2:1 rule.

TQP3M9028

High Linearity LNA Gain Block



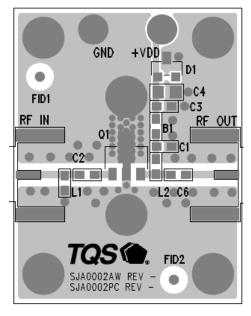
Device Characterization

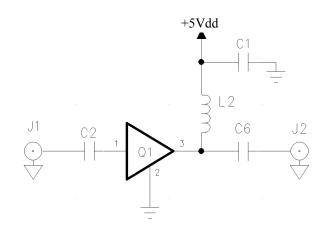
| $V_{dd} = +$ | $-5 \text{ V}, I_{dd} = 85$ | 5 mA, T = +25 | °C, calibrated to | device leads |
|--------------|-----------------------------|----------------|-------------------|--------------|
| | | | | |

| Freq (MHz) | S11 (dB) | S11 (ang) | S21 (dB) | S21 (ang) | S12 (dB) | S12 (ang) | S22 (dB) | S22 (ang) |
|------------|----------|-----------|----------|-----------|----------|-----------|----------|-----------|
| 50 | -17.781 | -79.977 | 16.426 | 168.24 | -19.626 | 4.3045 | -19.220 | -103.67 |
| 100 | -20.687 | -111.11 | 15.710 | 165.75 | -19.125 | -0.3832 | -19.244 | -133.67 |
| 200 | -23.728 | -139.82 | 15.333 | 161.88 | -18.801 | -5.7231 | -19.718 | -156.97 |
| 400 | -26.055 | -167.83 | 15.114 | 150.42 | -19.148 | -15.433 | -20.556 | 179.38 |
| 600 | -27.432 | -174.22 | 15.068 | 138.49 | -19.086 | -24.010 | -22.047 | 170.39 |
| 800 | -28.336 | 175.58 | 14.970 | 124.69 | -19.086 | -32.722 | -22.058 | 163.66 |
| 1000 | -28.090 | 168.62 | 14.889 | 112.00 | -19.259 | -42.486 | -23.024 | 152.72 |
| 1200 | -27.851 | 173.63 | 14.837 | 98.392 | -19.196 | -50.978 | -24.702 | 147.54 |
| 1400 | -27.744 | -176.1 | 14.787 | 85.391 | -19.461 | -59.544 | -27.618 | 150.45 |
| 1600 | -25.498 | -170.21 | 14.785 | 71.784 | -19.643 | -67.665 | -30.371 | 178.07 |
| 1800 | -23.299 | -171.85 | 14.681 | 58.795 | -19.718 | -76.829 | -30.117 | -137.55 |
| 2000 | -21.873 | -177.68 | 14.742 | 45.335 | -19.786 | -86.241 | -24.898 | -137.73 |
| 2200 | -19.991 | 174.69 | 14.585 | 31.380 | -20.202 | -94.784 | -21.473 | -136.81 |
| 2400 | -18.395 | 168.24 | 14.660 | 17.730 | -20.964 | -105.89 | -18.570 | -137.28 |
| 2600 | -16.954 | 156.32 | 14.540 | 3.3697 | -20.584 | -113.76 | -16.815 | -144.20 |
| 2800 | -15.635 | 143.92 | 14.468 | -10.871 | -21.081 | -123.83 | -15.001 | -146.29 |
| 3000 | -14.526 | 132.69 | 14.390 | -25.665 | -21.170 | -134.66 | -13.630 | -160.04 |
| 3200 | -13.585 | 121.19 | 14.321 | -40.604 | -21.463 | -143.32 | -12.590 | -169.39 |
| 3400 | -13.396 | 109.54 | 14.295 | -55.994 | -21.608 | -153.10 | -11.447 | -179.44 |
| 3600 | -13.267 | 95.204 | 14.103 | -71.813 | -22.114 | -164.82 | -10.288 | 168.78 |
| 3800 | -13.490 | 73.954 | 14.022 | -88.474 | -22.248 | -174.45 | -9.8699 | 161.57 |
| 4000 | -13.580 | 51.354 | 13.694 | -105.82 | -22.604 | 175.38 | -9.6061 | 156.49 |



Application Circuit Configuration





Notes:

- 1. See PC Board Layout, page 9 for more information.
- 2. Components shown on the silkscreen but not on the schematic are not used.
- 3. B1 (0 Ω jumper) may be replaced with copper trace in the target application layout.
- 4. The recommended component values are dependent upon the frequency of operation.
- 5. All components are of 0603 size unless stated on the schematic.

Bill of Material

| | Frequency (MHz) | | | | |
|-----------------------|------------------|------------------|--|--|--|
| Reference Designation | TQP3M9028-PCB_IF | TQP3M9028-PCB_RF | | | |
| | 50 - 500 | 500 - 4000 | | | |
| Q1 | TQP3M9028 | | | | |
| C2, C6 | 1000 pF | 100 pF | | | |
| C1 | 0.01 uF | 0.01 uF | | | |
| L2 | 330 nH | 68 nH | | | |
| L1, D1, C3, C4 | Do Not Place | | | | |
| B1 | 0 Ω | | | | |

Notes

1. Performances can be optimized at frequency of interest by using recommended component values shown in the table below.

| Reference | Frequency (MHz) | | | | |
|-------------|-----------------|-------|-------|-------|--|
| Designation | 500 | 2000 | 2500 | 3500 | |
| C2, C6 | 100 pF | 22 pF | 22 pF | 22 pF | |
| L2 | 82 nH | 22 nH | 18 nH | 15 nH | |

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Data Sheet: Rev D 10-12-11

Disclaimer: Subject to change without notice

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Typical Performance 500-4000 MHz

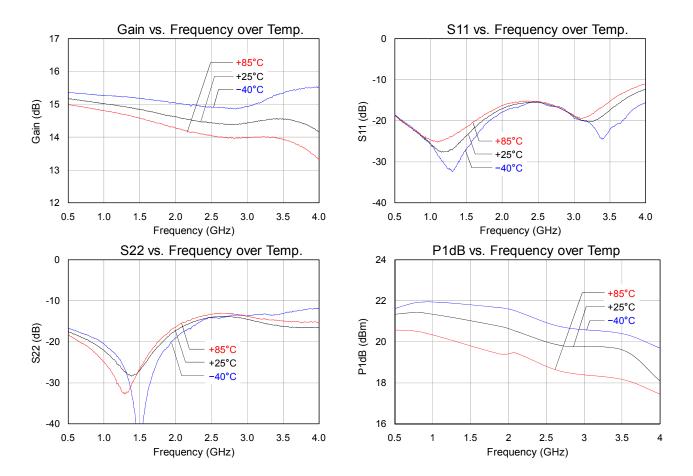
Test conditions unless otherwise noted: +25°C, +5V, 85 mA, 50 Ω system. The data shown below is measured on TQP3M9028-PCB RF.

| Frequency | MHz | 500 | 900 | 1900 | 2700 | 3500 | 4000 |
|--------------------|-----|-------|-------|-------|-------|-------|-------|
| Gain | dB | 15.2 | 15.1 | 14.7 | 14.4 | 14.6 | 14.2 |
| Input Return Loss | dB | 19 | 24 | 18 | 16 | 17 | 12 |
| Output Return Loss | dB | 17.5 | 21 | 19 | 14 | 16 | 16.5 |
| Output P1dB | dBm | +21.3 | +21.4 | +20.7 | +19.8 | +19.6 | +18.1 |
| OIP3 [1] | dBm | +40.6 | +40.1 | +40.3 | +36.2 | +33.2 | +29 |
| Noise Figure [2] | dB | 1.8 | 2 | 2 | 2.5 | | |

Notes:

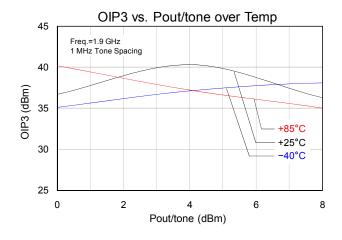
- 1. OIP3 measured with two tones at an output power of +4 dBm / tone separated by 1 MHz. The suppression on the largest IM3 product is used to calculate the OIP3 using 2:1 rule.
- 2. Noise figure data shown in the table above is measured on evaluation board which includes board losses of 0.1dB @ 2 GHz.

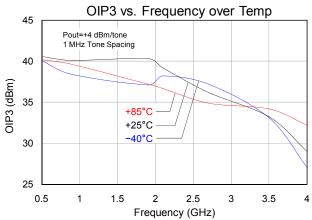
RF Performance Plots

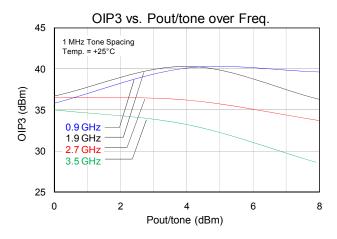


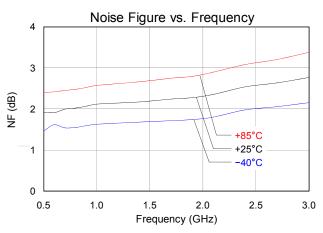


RF Performance Plots (cont.)











Typical Performance 50-500 MHz

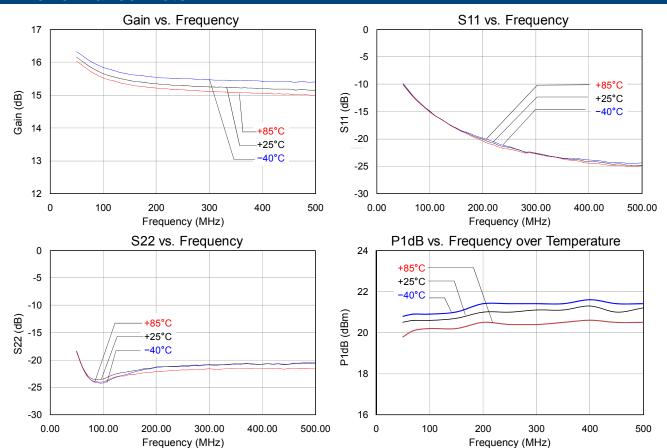
Test conditions unless otherwise noted: +25°C, +5V, 85 mA, 50 Ω system. The data shown below is measured on TQP3M9028-PCB_IF.

| Frequency | MHz | 70 | 100 | 200 | 500 |
|--------------------|-----|-------|-------|-------|-------|
| Gain | dB | 15.8 | 15.5 | 15.3 | 15.2 |
| Input Return Loss | dB | 13 | 15 | 20 | 25 |
| Output Return Loss | dB | 23 | 23 | 22 | 20.5 |
| Output P1dB | dBm | +20.6 | +20.6 | +21.0 | +21.2 |
| OIP3 [1] | dBm | +40.3 | +40.5 | +41.9 | +39.9 |
| Noise Figure [2] | dB | 1.8 | 1.7 | 1.7 | 1.8 |

Notes:

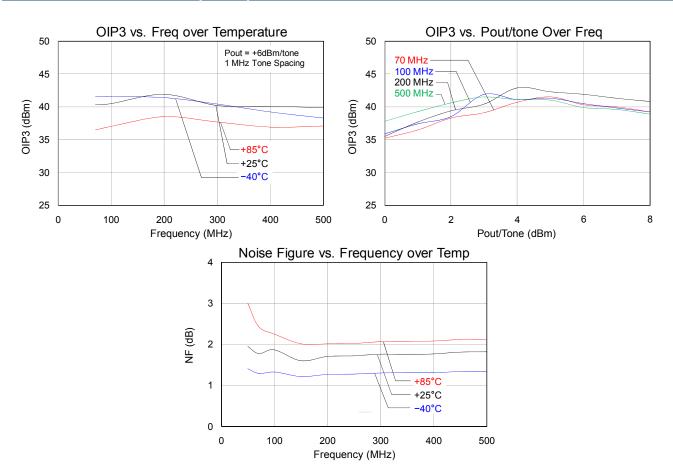
- 1. OIP3 measured with two tones at an output power of +6 dBm / tone separated by 1 MHz. The suppression on the largest IM3 product is used to calculate the OIP3 using 2:1 rule.
- 2. Noise figure data shown in the table above is measured on evaluation board which includes board losses of 0.1 dB @ 2 GHz.

IF Performance Plots



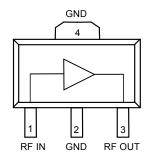


IF Performance Plots (cont.)





Pin Configuration and Description



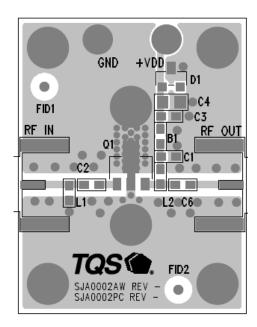
| Pin | Symbol | Description | | |
|------|-------------|--|--|--|
| 1 | RF IN | Input, matched to 50 ohms. External DC Block is required. | | |
| 2, 4 | GND | RF/DC Ground Connection | | |
| 3 | RFout / Vdd | Output, matched to 50 ohms, External DC Block is required and supply voltage | | |

Applications Information

PC Board Layout

Top RF layer is .014" NELCO N4000-13, ϵ_r = 3.9, 4 total layers (0.062" thick) for mechanical rigidity. Metal layers are 1-oz copper. 50 ohm Microstrip line details: width = .029", spacing = .035".

The pad pattern shown has been developed and tested for optimized assembly at TriQuint Semiconductor. The PCB land pattern has been developed to accommodate lead and package tolerances. Since surface mount processes vary from supplier to supplier, careful process development is recommended.

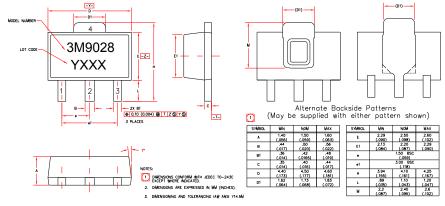




Mechanical Information

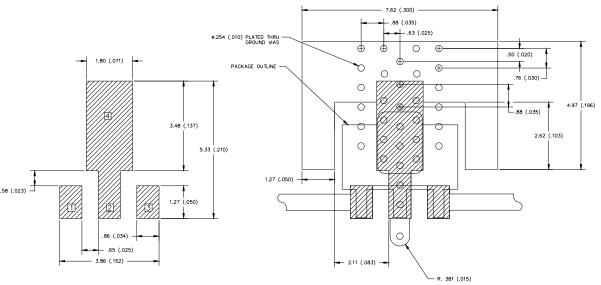
Package Information and Dimensions

The component will be marked with a "3M9028" designator with an alphanumeric lot code on the top surface of package. The "Y" represents the last digit of the year the part was manufactured; the "XXX" is an auto generated number.



Mounting Configuration

All dimensions are in millimeters (inches). Angles are in degrees.



Notes:

- 1. Ground / thermal vias are critical for the proper performance of this device. Vias should use a .35mm (#80 / .0135") diameter drill and have a final plated thru diameter of .25 mm (.010").
- 2. Add as much copper as possible to inner and outer layers near the part to ensure optimal thermal performance.
- 3. RF trace width depends upon the PC board material and construction.
- 4. Use 1 oz. Copper minimum.



Product Compliance Information

ESD Information



Caution! ESD-Sensitive Device

ESD Rating: Class 1A

Value: Passes ≥ 250V to < 500 V Test: Human Body Model (HBM) Standard: JEDEC Standard JESD22-A114

ESD Rating: CDM Class IV Value: Passes ≥ 1000 V

Test: Charged Device Model (CDM)
Standard: JEDEC Standard JESD22-C101

MSL Rating

The part is rated Moisture Sensitivity Level 3 at 260°C per JEDEC standard IPC/JEDEC J-STD-020.

Solderability

This package is lead-free/RoHS-compliant. The plating material on the leads is NiPdAu. It is compatible with both lead-free (maximum 260 °C reflow temperature) and lead (maximum 245 °C reflow temperature) soldering processes.

This part is compliant with EU 2002/95/EC RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment).

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A $(C_{15}H_{12}Br_4O_2)$ Free
- PFOS Free
- SVHC Free

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